



Product Change Notification

Change Notification #: 118186-00
Change Title: Select Intel® Optane™ Persistent Memory 200 Series
PCN 118186-00, Product Design, Firmware Update
Date of Publication: April 05, 2021

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	May 28, 2021
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Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

- The firmware version is being updated from CRFW_2.2.0.1516 to CRFW_2.2.0.1553.

The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware, and re-qualification is not recommended. Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible. Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
Intel® Optane™ Persistent Memory 200 Series (128GB PMEM Module) 4 Pack	NMB1XXD128GPSU4	999HGR	K69576-201	K70232-201	K69576-202	K70232-202
Intel® Optane™ Persistent Memory 200 Series (128GB PMEM Module) 50 Pack	NMB1XXD128GPSUF	999HGZ	K92508-201	K70232-201	K92508-202	K70232-202
Intel® Optane™ Persistent Memory 200 Series (256GB PMEM Module) 4 Pack	NMB1XXD256GPSU4	999HH0	K69577-201	K70233-201	K69577-202	K70233-202
Intel® Optane™ Persistent Memory 200 Series (256GB PMEM Module) 50 Pack	NMB1XXD256GPSUF	999HH1	K92509-201	K70233-201	K92509-202	K70233-202
Intel® Optane™ Persistent Memory 200 Series (512GB PMEM Module) 4 Pack	NMB1XXD512GPSU4	999HH2	K69578-201	K70234-201	K69578-202	K70234-202
Intel® Optane™ Persistent Memory 200 Series (512GB PMEM Module) 50 Pack	NMB1XXD512GPSUF	999HH3	K92510-201	K70234-201	K92510-202	K70234-202

PCN Revision History:

Date of Revision:

April 05, 2021

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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